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November 2013

FCB36N60N N-Channel SupreMOS[®] MOSFET

600 V, 36 A, 90 mΩ

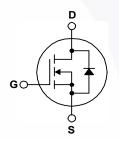
Features

- R_{DS(on)} = 81 mΩ (Typ.) @ V_{GS} = 10 V, I_D = 18 A
- Ultra Low Gate Charge (Typ. Qg = 86 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 361 pF)
- 100% Avalanche Tested
- · RoHS Compliant

Applications

- Solar Inverter
- AC-DC Power Supply





The SupreMOS® MOSFET is Fairchild Semiconductor's next

generation of high voltage super-junction (SJ) technology

employing a deep trench filling process that differentiates it from

the conventional SJ MOSFETs. This advanced technology and

precise process control provides lowest Rsp on-resistance,

superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV

power, ATX power, and industrial power applications.

Description

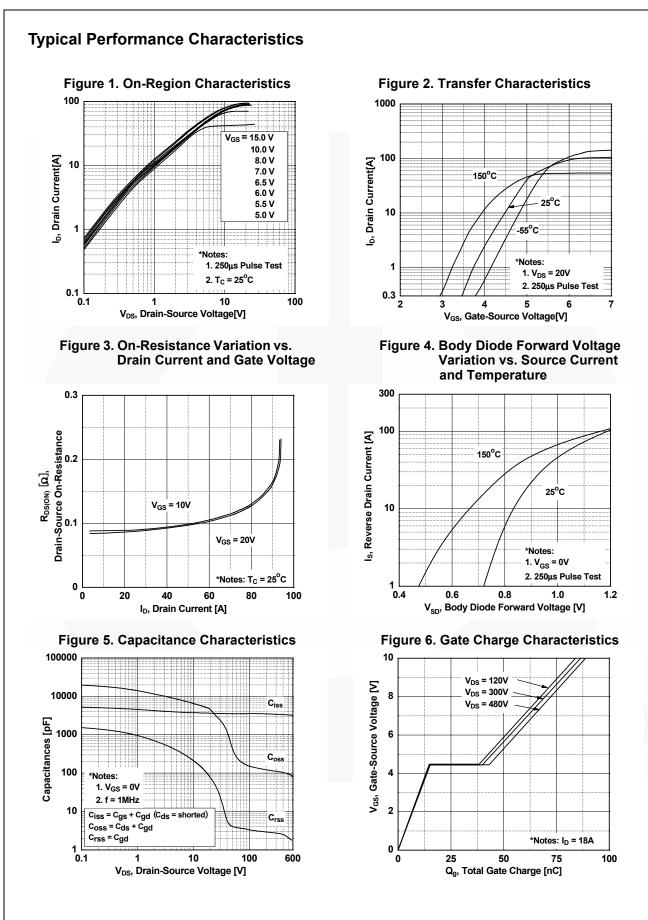
MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter			FCB36N60N	Unit
V _{DSS}	Drain to Source Voltage			600	V
V _{GSS}	Gate to Source Voltage			±30	V
	Drain Current	- Continuous (T _C = 25 ^o C)		36	
I _D		- Continuous (T _C = 100 ^o C)		22.7	- A
I _{DM}	Drain Current	- Pulsed (Note 1)		108	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			1800	mJ
I _{AR}	Avalanche Current (Note 1)			12	А
E _{AR}	Repetitive Avalanche Energy (Note 1)			3.12	mJ
dv/dt	MOSFET dv/dt			100	V/ns
Peak Diode Recovery dv/dt		(Note 3)	20	V/ns
P _D	Dower Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		312	W
	Power Dissipation	- Derate Above 25°C		2.6	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		s	300	°C

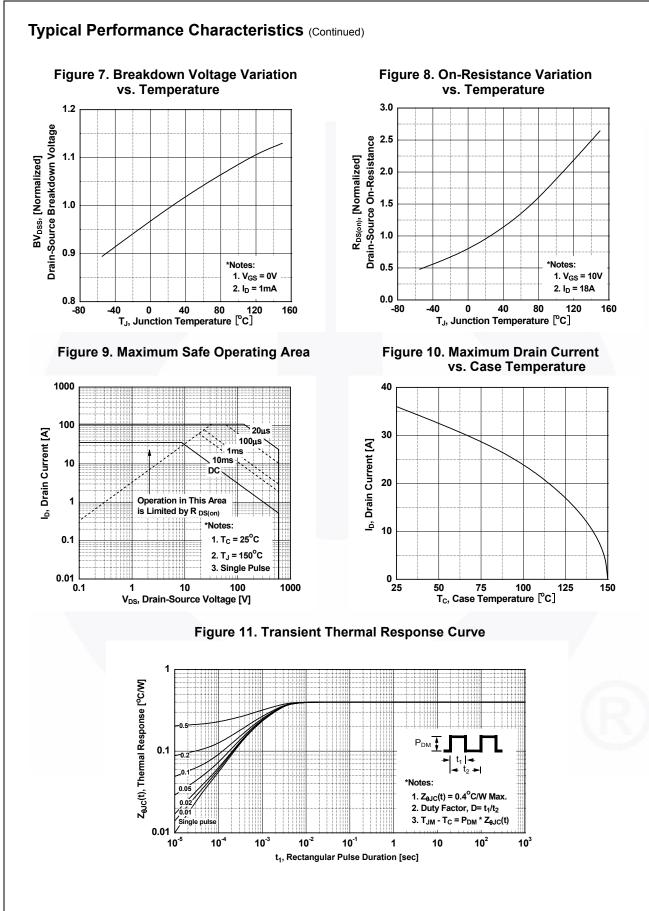
Thermal Characteristics

Symbol	Parameter	FCB36N60N	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.4	
R_{\thetaJA}	$R_{\theta JA}$ Thermal Resistance, Junction to Ambient (1 in ² Pad of 2-oz Copper), Max.		°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5]

Part Number Top Mark Pac		Packag	e Packing M	ethod	Reel Size	Tape Width		Qua	ntity	
FCB36N			D ² -PAK	Tape and	Reel	330 mm	2	4 mm	800 units	
Electrica	l Chara	acteristics T _C =:	25°C unless	otherwise noted						
Symbol	~			Test Conditions			Min.	Тур.	Max.	Unit
Off Charac	cteristics	;								
BV _{DSS}	Drain to Source Breakdown Voltage		ltage	I _D = 1 mA, V _{GS} = 0 V, T _C = 25 ^o C			600	-	-	V
ΔBV _{DSS} /ΔTJ	Breakdown Voltage Temperature Coefficient		re	$I_D = 1$ mA, Referenced to $25^{\circ}C$			-	0.7	-	V/ºC
ı.	7000 004			V _{DS} = 480 V, V _{GS} = 0 V		-	-	10		
DSS	Zero Gat	Zero Gate Voltage Drain Current		$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_C = 125^{\circ}\text{C}$		-	-	100	μA	
I _{GSS}	Gate to E	Body Leakage Current		V _{GS} = ±30 V, V			-	-	±100	nA
On Charac	teristics	i								
V _{GS(th)}	Gate Thr	reshold Voltage		$V_{GS} = V_{DS}, I_D$	= 250 μA		2.0	-	4.0	V
R _{DS(on)}	Static Dr	ain to Source On Resi	stance	V_{GS} = 10 V, I_D	= 18 A		-	81	90	mΩ
9 _{FS}	Forward	Transconductance		V _{DS} = 40 V, I _D = 18 A		-	41	-	S	
Dynamic (Characte	ristics								
C _{iss}	T	pacitance		V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz		-	3595	4785	pF	
C _{oss}	Output C	apacitance				-	149	200	pF	
C _{rss}	Reverse	Transfer Capacitance				-	4	6	pF	
C _{oss}	Output Capacitance			V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz			-	80	-	pF
C _{oss(eff.)}	Effective	Output Capacitance		$V_{DS} = 0 V \text{ to } 380 V, V_{GS} = 0 V$		-	361	-	pF	
Q _{g(tot)}	Total Gat	te Charge at 10V		V _{DS} = 380 V, I _D = 18 A, V _{GS} = 10 V (Note 4) f = 1 MHz			-	86	112	nC
Q _{gs}	Gate to S	Source Gate Charge				-	15.4	-	nC	
Q _{gd}	Gate to D	Drain "Miller" Charge				-	26.4	-	nC	
ESR	Equivale	nt Series Resistance (G-S)			-	1	-	Ω	
Switching	Charact	eristics								
t _{d(on)}	Turn-On	Delay Time						23	56	ns
t _r	Turn-On Rise Time			V _{DD} = 380 V, I _D = 18 A,		-	22	54	ns	
t _{d(off)}	Turn-Off	Delay Time		$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$ (Note 4)		-	94	198	ns	
t _f	Turn-Off	Fall Time				-	4	18	ns	
Drain-Sou	rce Diod	e Characteristics								
I _S				e Forward Curre	nt		_	-	36	Α
I _{SM}	Maximum Continuous Drain to Source Dio Maximum Pulsed Drain to Source Diode F					-	-	108	A	
V _{SD}	Drain to Source Diode Forward Voltage			$V_{GS} = 0 V$, $I_{SD} = 18 A$		-	- /	1.2	V	
t _{rr}		Recovery Time	Vollago	$V_{GS} = 0.V, I_{SD} = 18 \text{ A}$ $V_{GS} = 0.V, I_{SD} = 18 \text{ A},$ $dI_{F}/dt = 100 \text{ A}/\text{\mu s}$		-	574	-	ns	
Q _{rr}		Recovery Charge				-	10	-	μC	
an		receivery charge						10		μο



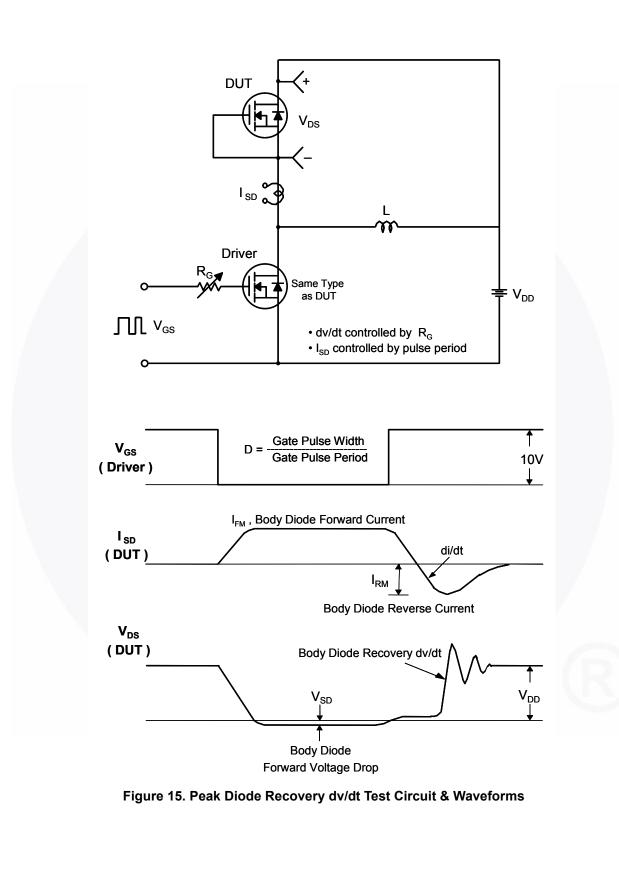
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 V_{GS} ξ א Q_g FV_{DS} Q_{gd} Q_{gs} • DUT I_G = const. Charge Figure 12. Gate Charge Test Circuit & Waveform R VDS V_{DS} 90% ο V_{DD} GS R_{G} 10% V_{GS} DUT V_{GS} ∏ 0 Figure 13. Resistive Switching Test Circuit & Waveforms L $E_{AS} = \frac{1}{2} L I_{AS}^2$ V_{DS} $\mathsf{BV}_{\mathsf{DSS}}$ ID o I_{AS} R_{G} ŧν_{DD} $I_{D}(t)$ $\mathsf{V}_{\mathsf{D}\mathsf{D}}$ V_{GS}] $V_{DS}(t)$ DUT Time t_p Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

FCB36N60N — N-Channel SupreMOS[®] MOSFET



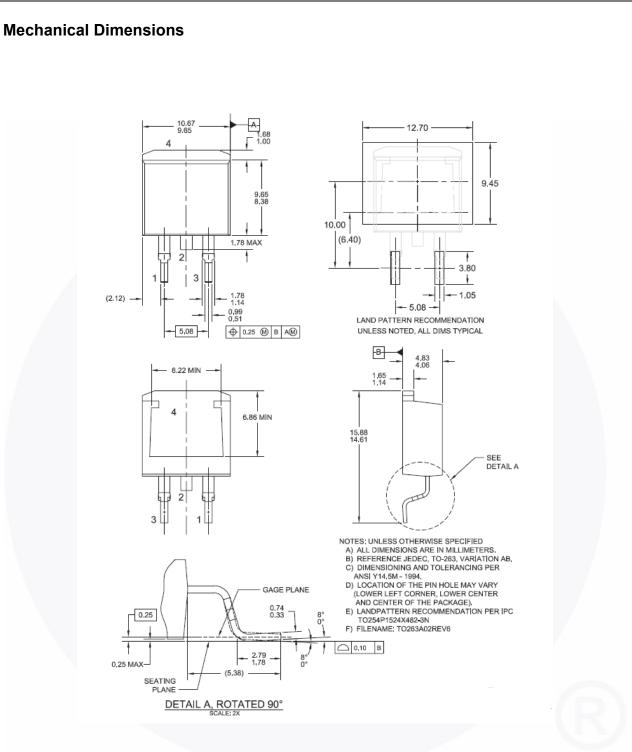


Figure 16. TO263 (D²PAK), Molded, 2-Lead, Surface Mount

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